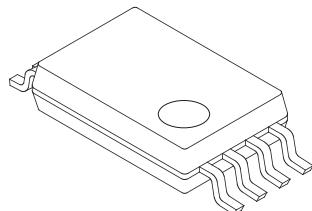


TX Gain Control Amplifier

Description

CXA3222AN is a TX gain control amplifier suitable for CDMA cellular/PCS phone.

8 pin SSOP (Plastic)



Features

- Wide gain control range
- Linear gain slope
- Wideband operation (50 MHz to 300 MHz)
- Very small package (8 Pin SSOP)
- Low voltage operation
- High output IP3
- Power save function included

Absolute Maximum Ratings

• Supply voltage	Vcc	6	V
• Operating temperature	Toopr	-55 to +125	°C
• Storage temperature	Tstg	-65 to +150	°C
• Supply voltage range		-0.3 to 6	V
• Logic input voltage		-0.3 to Vcc + 0.3	V
• Signal input voltage		-0.3 to Vcc + 0.3	V
• Differential signal input voltage		0 to 2.5	V

Operating Condition

Supply voltage Vcc 2.7 to 3.8 V

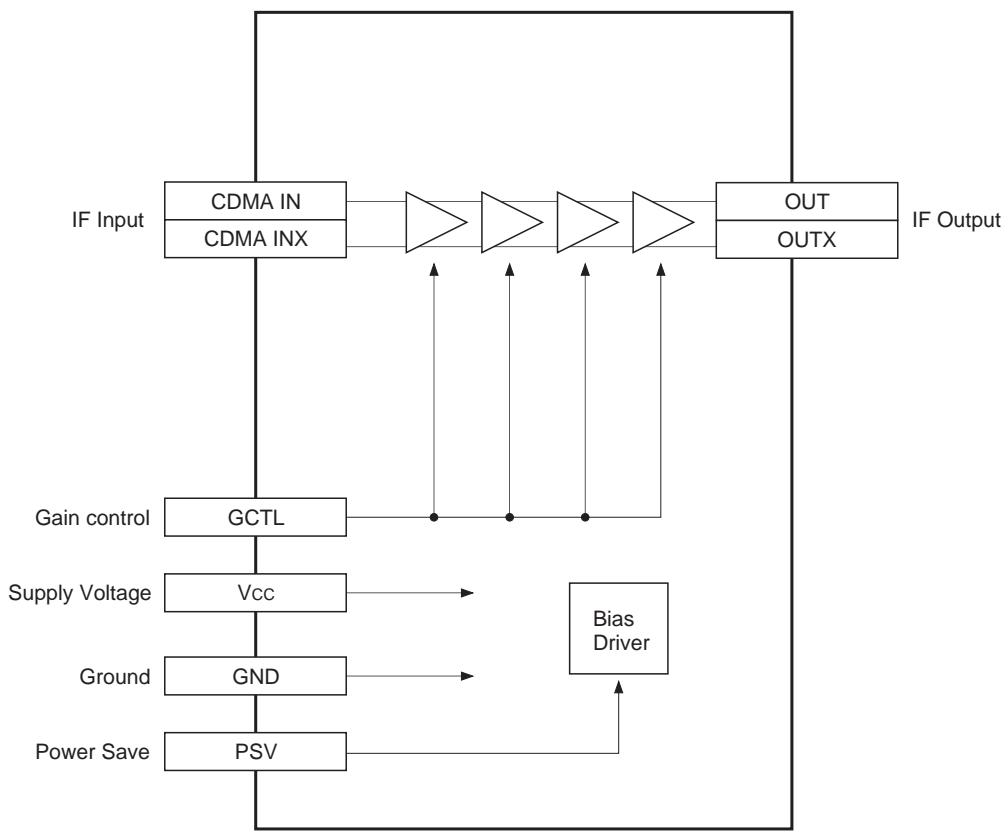
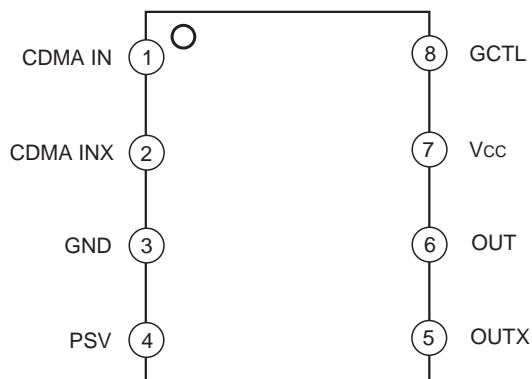
Applications

CDMA cellular/PCS phone

Structure

Bipolar silicon monolithic IC

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Block Diagram**Pin Configuration**

Pin Description

Pin No.	Symbol	Pin voltage TYP (V)	Equivalent circuit	Description
1	CDMA IN	1.1		Differential input pins for CDMA transmit IF signal.
2	CDMA INX	1.1		
3	GND	0		Ground.
4	PSV	—		Power save function pin. High: Active Low: Power save
5	OUTX	—		Differential output pins for transmit IF signal.
6	OUT	—		Open collector output.
7	Vcc	3.0		Positive power supply.
8	GCTL	—		Gain control pin.

Electrical Characteristics**DC Characteristics**

(Vcc=3.0 V, Ta=27 °C)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Current consumption 1	Icc1	Vpsv=3.0 V, Vgctl=1.5 V, Pin 7	10	15.7	21.5	mA
Current consumption 2	Icc2	Vpsv=0 V, Vgctl=1.5 V, Pin 7	5	18	40	
Input current pin 4H	IpsvH	Vpsv=3.0 V			1	
Input current pin 4L	IpsvL	Vpsv=0 V	-15			
Input current pin 8H	IgctlH	Vgctl=3.0 V			1	
Input current pin 8L	IgctlL	Vgctl=0.5 V	-1			
PSV high voltage	VpsH	Pin 4	2.5			
PSV low voltage	VpsL	Pin 4			0.5	V

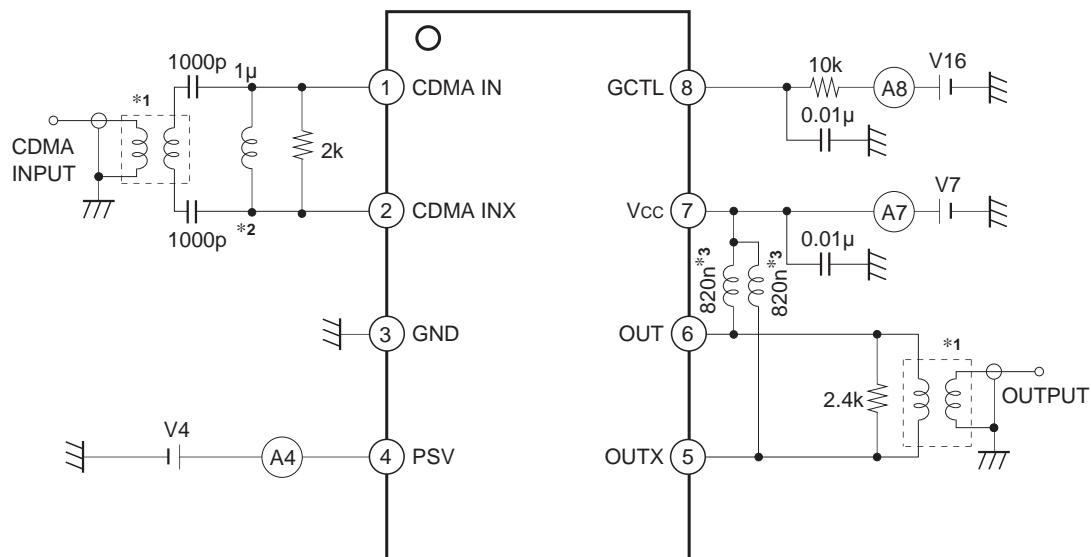
AC Characteristics

(Vcc=3.0 V, Ta=27 °C)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Operating frequency range	Fr		50		300	MHz
Gain 2.3	G2.3	f=130.38 MHz, level=-22.5 dBm, Vgctl=2.3 V	13	17	21	
Gain 1.5	G1.5	Vgctl=1.5 V	-28	-24	-20	
Gain 1.0	G1.0	Vgctl=1.0 V	-58	-54	-50	
Gain 0.7	G0.7	Vgctl=0.7 V	-75	-70	-65	
Gain slope	GCLIN	Gain at Vgctl=2.0 V – Gain at Vgctl=1.0 V	57	60	63	
Input level 3rd order intercept point	IIP3	G=15 dB *1 f1=129.38 MHz, f2=131.38 MHz Measure of 130.38 MHz	-8.5	-4.5		
Noise Figure	NF	G=15 dB *1 Measure of 130.38 MHz		28	32	dB

*1 Adjust GCTL voltage, and set the overall gain to 15 dB.

Measurement Circuit

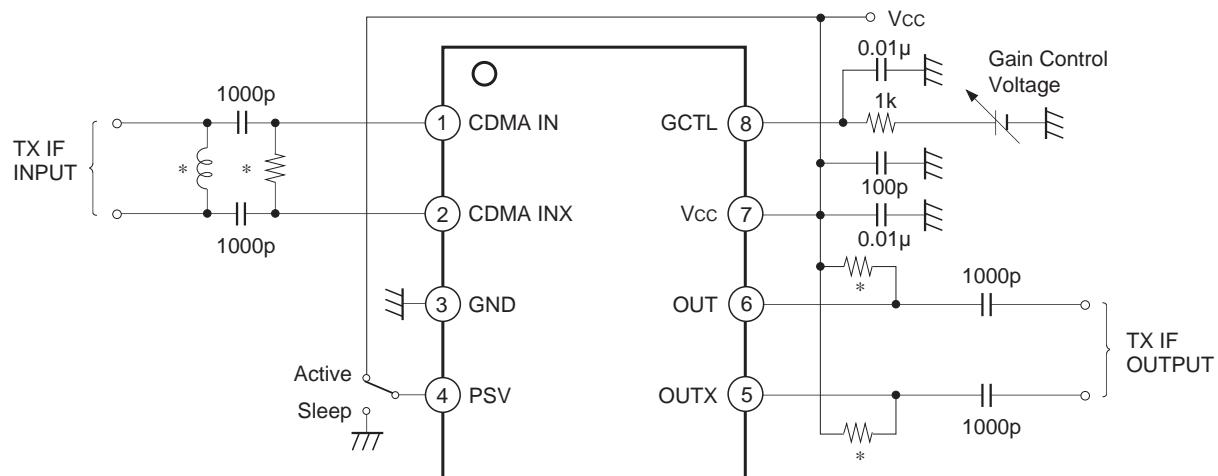


*1 TOKO, Inc. B5FL 616DS-1135

*2 Coilcraft, Inc. 1008HS-102TKBC

*3 Coilcraft, Inc. 1008HS-821TKBC

Application Circuit



* Must be adjusting values to result a best impedance matching between BPF filter and this IC.

Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party patent and other right due to same.

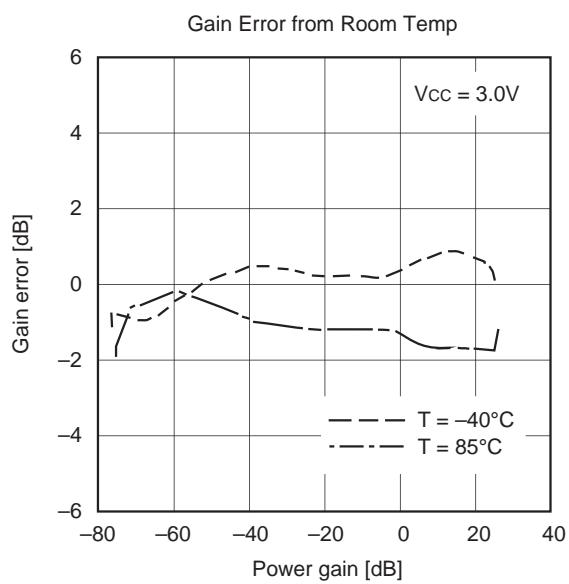
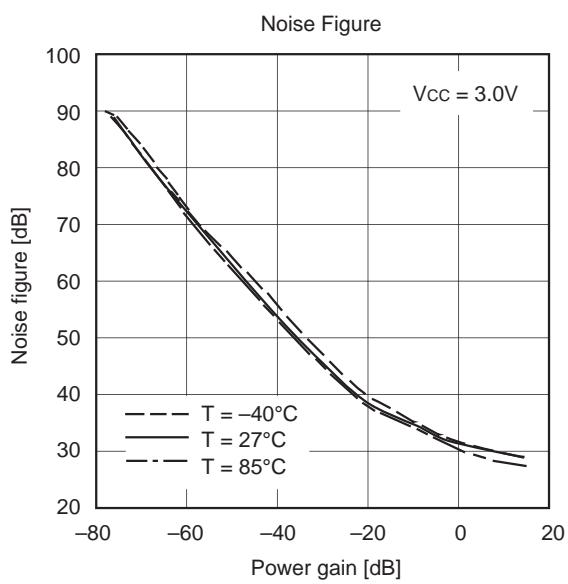
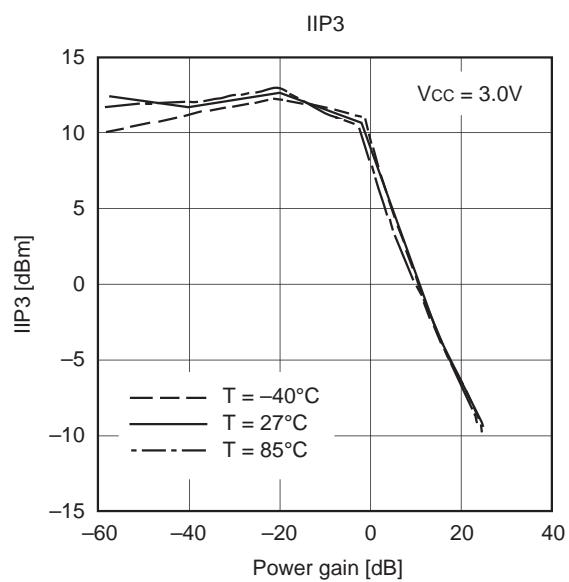
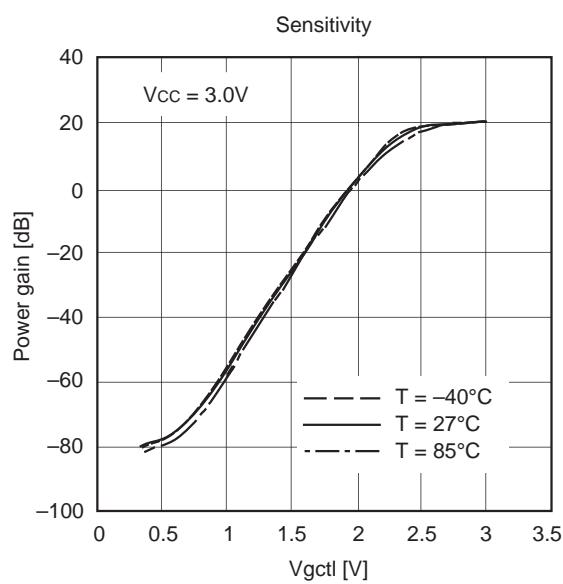
Design Reference Values**Single ended measurement**

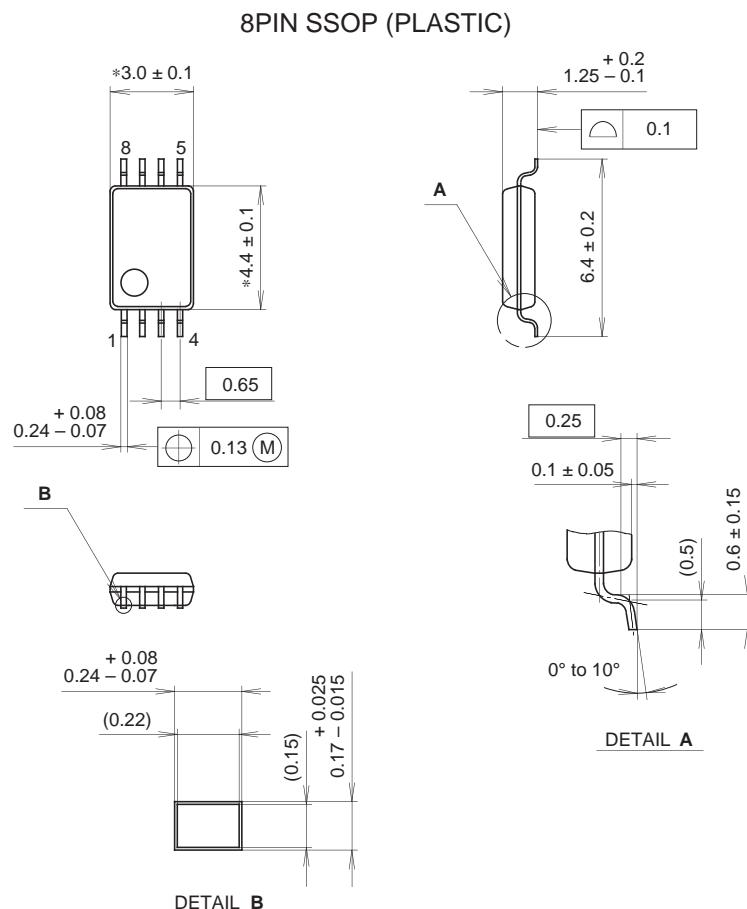
(Vcc=3.0 V, Ta=27 °C)

Item	Symbol	Conditions	Typ.	Unit
Input resistance	Rin	f=130.38 MHz, Vgctl=1.5 V	10	kΩ
Input capacitance	Cin		0.92	pF
Output resistance	Rout		6	kΩ
Output capacitance	Cout		0.9	pF

Notes on Operation

- 1) This IC is a wideband amplifier with wide gain control range. The decoupling capacitors between GND Pin and Vcc Pin should be as close to the IC as possible.
- 2) The resistors connected to Pins 5 and 6 should be as close to the IC as possible.
- 3) This IC assumes the excellent characteristics when the differential input impedance between Pins 1 and 2 is 500Ω. Refer to the Measurement Circuit for the external element settings, etc.
- 4) Pay attention to handling this IC because its electrostatic discharge strength is weak.



Package Outline Unit : mm


NOTE: Dimension "*" does not include mold protrusion.

PACKAGE STRUCTURE

SONY CODE	SSOP-8P-L01
EIAJ CODE	SSOP008-P-0044
JEDEC CODE	_____

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER / PALLADIUM PLATING
LEAD MATERIAL	COPPER ALLOY
PACKAGE MASS	0.04g